



SURFACE MOUNT SCHOTTKY BARRIER DIODE

Features

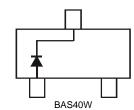
- Low Forward Voltage Drop
- Fast Switching
- Ultra-Small Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- Lead Free/RoHS Compliant (Note 3)
- "Green" Device (Note 4 and 5)

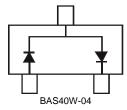
Mechanical Data

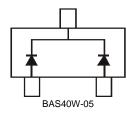
- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 4. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagrams Below
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.006 grams (approximate)

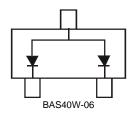


Top View









Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	40	٧	
RMS Reverse Voltage	V _{R(RMS)}	28	V	
Forward Continuous Current (Note 1)	I _{FM}	200	mA	
Non-Repetitive Peak Forward Surge Current @ t = 1.0s	I _{FSM}	600	mA	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	P _D	200	mW
Thermal Resistance Junction to Ambient Air (Note 1)	$R_{ heta JA}$	625	°C/W
Operating Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	T _{STG}	-65 to +150	°C

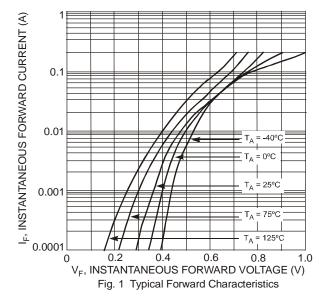
Electrical Characteristics @T_A = 25°C unless otherwise specified

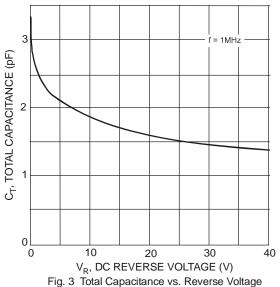
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	$V_{(BR)R}$	40		V	$I_R = 10\mu A$
Forward Voltage	VF	_	380 1000		$I_F = 1.0 \text{mA}, t_p < 300 \mu \text{s}$ $I_F = 40 \text{mA}, t_p < 300 \mu \text{s}$
Leakage Current (Note 2)	I _R	_	200	nA	$V_R = 30V$
Total Capacitance	C _T	_	5.0	pF	$V_R = 0$, $f = 1.0MHz$
Reverse Recovery Time	t _{rr}	_	5.0	ns	$I_F = I_R = 10\text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100\Omega$

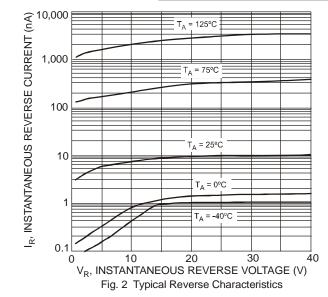
Notes:

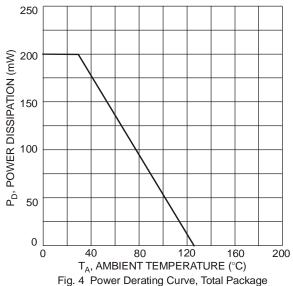
- 1. Device mounted on FR4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 2. Short duration pulse test used to minimize self-heating effect.
- 3. No purposefully added lead.
- 4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- 5. Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.









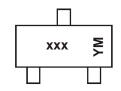


Ordering Information (Notes 5 & 6)

Part Number	Case	Packaging
BAS40W-7-F	SOT-323	3000/Tape & Reel
BAS40W-04-7-F	SOT-323	3000/Tape & Reel
BAS40W-05-7-F	SOT-323	3000/Tape & Reel
BAS40W-06-7-F	SOT-323	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



xxx = Product Type Marking Code

K43 = BAS40W

K44 = BAS40W-04 K45 = BAS40W-05

K46 = BAS40W-06

YM = Date Code Marking

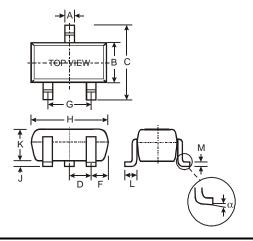
Y = Year (ex: N = 2002)

M = Month (ex: 9 = September)

Date Code Key								M = Moi	nth (ex: 9	e Sept	tember)					
Year	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015
Code	L	М	N	Р	R	S	Т	U	V	W	Х	Υ	Z	Α	В	С
Month	Jan	F	eb	Mar	Apr	N	lay	Jun	Jul	Α	ug	Sep	Oct	No	ov	Dec
Code	1		2	3	4		5	6	7		8	9	0	1	1	D

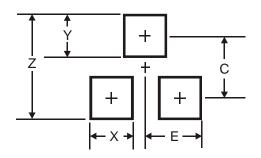


Package Outline Dimensions



	SOT-323						
Dim	Min Max Typ						
Α	0.25	0.40	0.30				
В	B 1.15 1.35 1.3						
С	2.00	2.20	2.10				
D	D 0.65						
F	0.30 0.40 0.42						
G	1.20	1.40	1.30				
Н	1.80	2.20	2.15				
J	0.0	0.10	0.05				
K	0.90	1.00	1.00				
L	0.25	0.40	0.30				
М	0.10	0.18	0.11				
α	0°	8°	-				
All	All Dimensions in mm						

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.8
Х	0.7
Υ	0.9
С	1.9
E	1.0

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